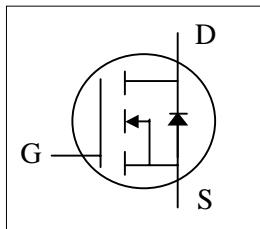




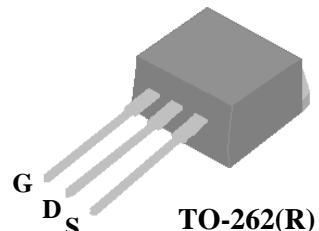
- ▼ Low Gate Charge
- ▼ Single Drive Requirement
- ▼ RoHS Compliant



BV_{DSS}	60V
$R_{DS(ON)}$	18mΩ
I_D	60A

Description

Advanced Power MOSFETs from APEC provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	60	V
V_{GS}	Gate-Source Voltage	+25	V
$I_D @ T_C = 25^\circ C$	Continuous Drain Current, $V_{GS} @ 10V$	60	A
$I_D @ T_C = 100^\circ C$	Continuous Drain Current, $V_{GS} @ 10V$	38	A
I_{DM}	Pulsed Drain Current ¹	230	A
$P_D @ T_C = 25^\circ C$	Total Power Dissipation	89	W
	Linear Derating Factor	0.7	W/°C
E_{AS}	Single Pulse Avalanche Energy ³	45	mJ
I_{AR}	Avalanche Current ³	30	A
T_{STG}	Storage Temperature Range	-55 to 150	°C
T_J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Value	Units
R_{thj-c}	Maximum Thermal Resistance, Junction-case	1.4	°C/W
R_{thj-a}	Maximum Thermal Resistance, Junction-ambient	62	°C/W

**Electrical Characteristics@T_j=25°C(unless otherwise specified)**

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250uA	60	-	-	V
ΔBV _{DSS} / ΔT _j	Breakdown Voltage Temperature Coefficient	Reference to 25°C, I _D =1mA	-	0.06	-	V/°C
R _{DS(ON)}	Static Drain-Source On-Resistance ²	V _{GS} =10V, I _D =35A	-	-	18	mΩ
		V _{GS} =4.5V, I _D =25A	-	-	22	mΩ
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250uA	1	-	3	V
g _{fs}	Forward Transconductance	V _{DS} =10V, I _D =35A	-	55	-	S
I _{DSS}	Drain-Source Leakage Current	V _{DS} =60V, V _{GS} =0V	-	-	10	uA
	Drain-Source Leakage Current (T _j =125°C)	V _{DS} =48V, V _{GS} =0V	-	-	250	uA
I _{GSS}	Gate-Source Leakage	V _{GS} =±25V, V _{DS} =0V	-	-	±100	nA
Q _g	Total Gate Charge ²	I _D =35A	-	32	51	nC
Q _{gs}	Gate-Source Charge	V _{DS} =48V	-	8	-	nC
Q _{gd}	Gate-Drain ("Miller") Charge	V _{GS} =4.5V	-	20	-	nC
t _{d(on)}	Turn-on Delay Time ²	V _{DS} =30V	-	11	-	ns
t _r	Rise Time	I _D =35A	-	58	-	ns
t _{d(off)}	Turn-off Delay Time	R _G =3.3Ω, V _{GS} =10V	-	45	-	ns
t _f	Fall Time	R _D =0.86Ω	-	80	-	ns
C _{iss}	Input Capacitance	V _{GS} =0V	-	3170	5070	pF
C _{oss}	Output Capacitance	V _{DS} =25V	-	280	-	pF
C _{rss}	Reverse Transfer Capacitance	f=1.0MHz	-	230	-	pF
R _g	Gate Resistance	f=1.0MHz	-	1.7	-	Ω

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V _{SD}	Forward On Voltage ²	I _S =35A, V _{GS} =0V	-	-	1.2	V
t _{rr}	Reverse Recovery Time ²	I _S =35A, V _{GS} =0V,	-	50	-	ns
Q _{rr}	Reverse Recovery Charge	dl/dt=100A/μs	-	48	-	nC

Notes:

- 1.Pulse width limited by Max. junction temperature.
- 2.Pulse test
- 3.Starting T_j=25°C , V_{DD}=30V , L=100uH , R_G=25Ω , I_{AS}=30A.

THIS PRODUCT IS SENSITIVE TO ELECTROSTATIC DISCHARGE, PLEASE HANDLE WITH CAUTION.

USE OF THIS PRODUCT AS A CRITICAL COMPONENT IN LIFE SUPPORT OR OTHER SIMILAR SYSTEMS IS NOT AUTHORIZED.

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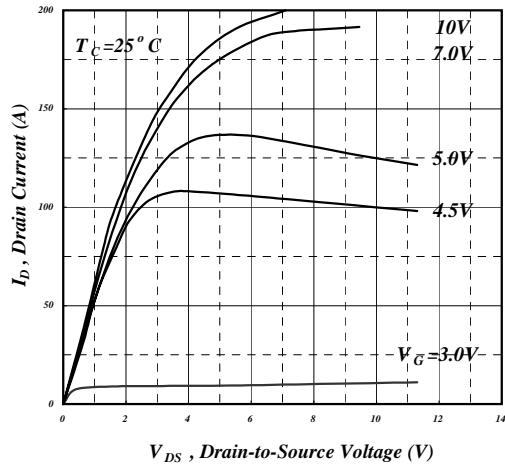


Fig 1. Typical Output Characteristics

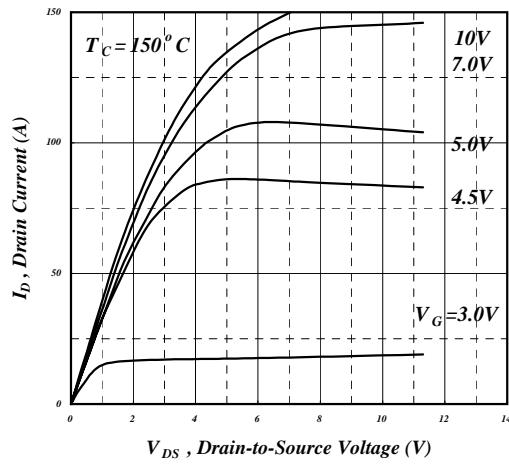


Fig 2. Typical Output Characteristics

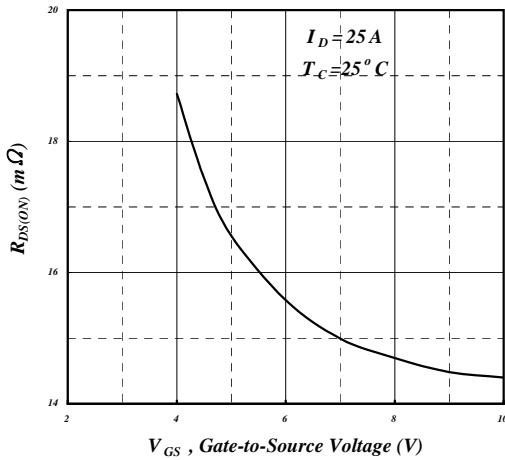


Fig 3. On-Resistance v.s. Gate Voltage

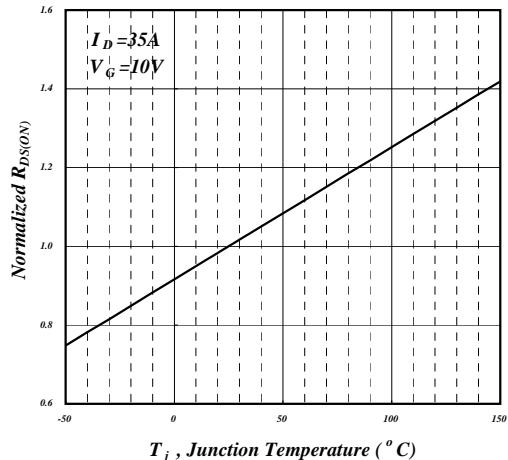


Fig 4. Normalized On-Resistance v.s. Junction Temperature

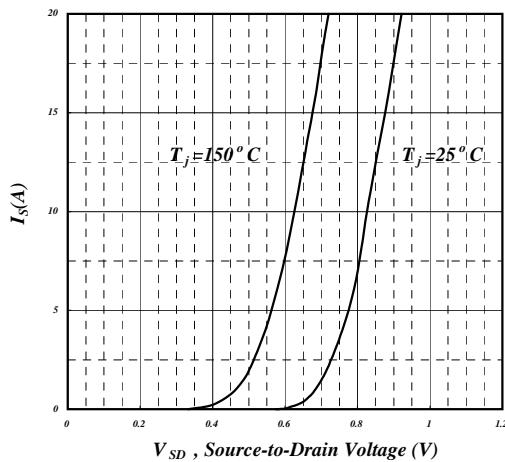


Fig 5. Forward Characteristic of Reverse Diode

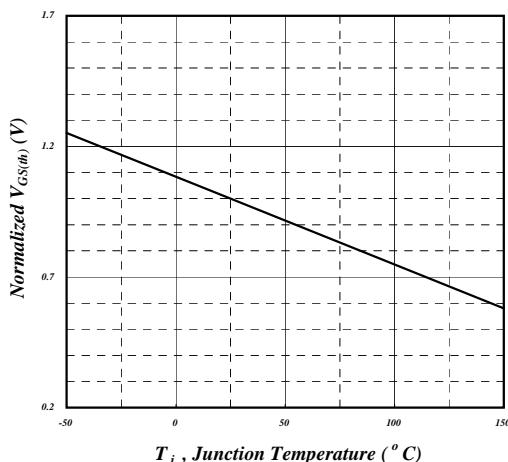


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

